# BRIGHT LED ELECTRONICS CORP.

## LED LAMPS SPECIFICATION

• COMMODITY: T-1 Standard 1.0"Lead, 5  $\phi$ 

●DEVICE NUMBER: BL-BK83R4V-1 PAGE:

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VERSION: 1.0

●ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta=25°C)

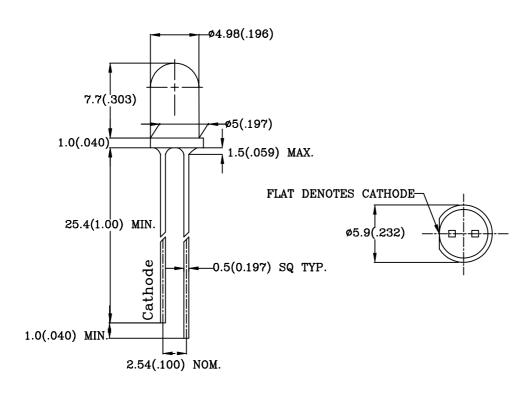
Chip			Absolute Maximum			Electro-optical					
	Peak	Lens	Rating				Data (At 20mA)				Viewing Angle
Emitted Color	Wave Length λ P(nm)	Appearance	$\Delta \lambda$ (nm)	Pd (mW)	If (mA)	Peak If(mA)	Vf(V)		Iv Typ. (mcd)		$2\theta 1/2$ (deg)
							Тур.	Max.	Min	Тур	( '8)
Super Yellow	587	Water Clear	15	100	30	150	2.2	2.6	1600	3000	18±3

Remark: Viewing angle is the Off-axis angle at which the luminous intensity is half the axial luminous intensity.

# ● ABSOLUTE MAXIMUN RATINGS (Ta=25°C)

Reverse Voltage	. <b></b> .		5V
Reverse Current (-Vr=5V)			
Operating Temperature Range			•
Storage Temperature Range	-40°C	~	85°C
Lead Soldering Temperature	°C For	5 S	econds

#### ●PACKAGE DIMENSIONS



NOTES: 1.All dimensions are in millimeters (inches).

- 2. Tolerance is  $\pm$  0.25mm (0.01") unless otherwise specified.
- 3.Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

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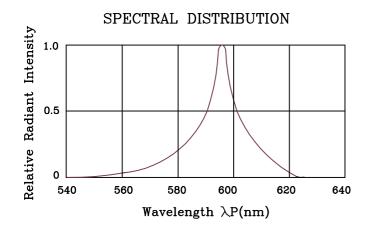
● COMMODITY: T-1 3/4 Standard 1.0"Lead,5ø

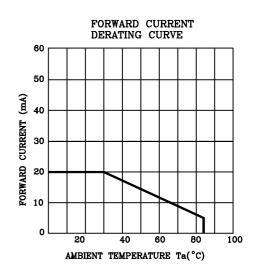
● DEVICE NUMBER: BL-BK83R4V-1

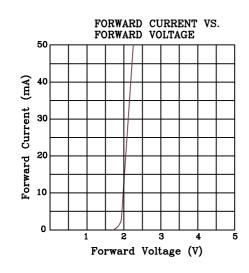
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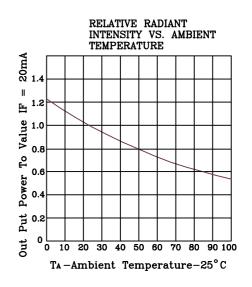
• ELECTICAL AND OPTICAL CHARACTERISTICS(Ta=25 °C)

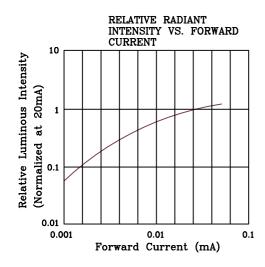
REVISION: 1.0

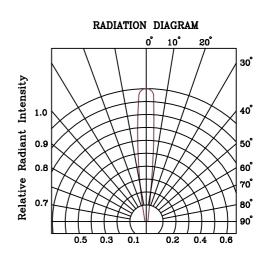












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# LED LAMP SPECIFICATION

## **RELIABILITY TEST**

REVISION: 1.0

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Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS C 7021 :B-1	Connect with a power If=30mA Ta=Under room temperature Test time=1,000hrs	0/100
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS C 7021 :B-11	Ta=85°C±5°C RH=90%-95% Test time=1,000hrs	0/100
	High Temperature Storage	MIL-STD-883:1008 JIS C 7021 :B-10	High Ta=85°C±5°C Test time=1,000hrs	0/100
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/100
Environment al Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS C 7021 :A-4	-35°C ~25°C ~85°C ~25°C 30min 5min 30min 5min Test Time=10cycle	0/100
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	85°C±5°C ~ -35°C±5°C 10min 10min Test Time=10cycle	0/100
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS C 7021 :A-1	T.sol=260±5°C Dwell Time=10±1sec.	0/50
	Solderability	MIL-STD-202:208D MIL-STD-750:2026 MIL-STD-883:2003 JIS C 7021 :A-2	T.sol=230±5°C Dwell Time=5±1sec.	0/50
	Lead Bending Stress	MIL-STD-750:2036 JIS C 7021 :A-11	0°~90°~0°bend , 3 cycles Weight 250g	0/50

## JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	VF	IF=20mA	Over Ux1.2
Reverse current	IR	VR=5V	Over Ux2
Luminous intensity	IV	IF=20mA	Below Sx0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.